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Specification document

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SPECIFICATION OF LCD MODULE

MODULE NO.: HL24064M02-01WFPTC

	SIGNATURE	DATE
	SIGNATURE	DAIL
PREPARED BY		
CHECKED BY		
APPROVED BY		

DOCUMENT REVISION HISTORY

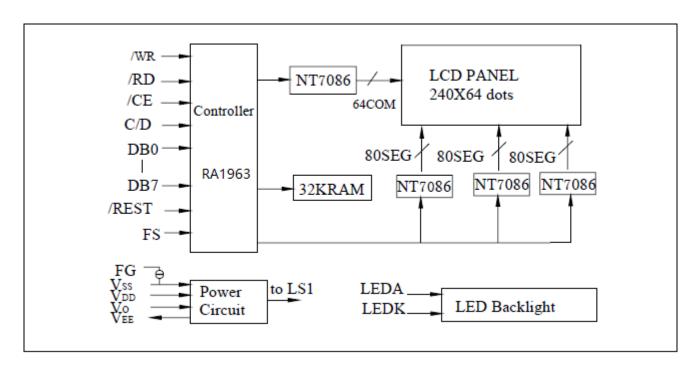
Sample Version	Doc. Version	DATE	DESCRIPTION	CHECKED BY
	A0	2023-04-20	First Release.	
	A1	2023-4-27	Modify pin20, BL parameter	
			Cable length	
	A2	2023-5-8	Modify BL life time	
			·	

1. MECHANICAL SPECIFICATIONS:

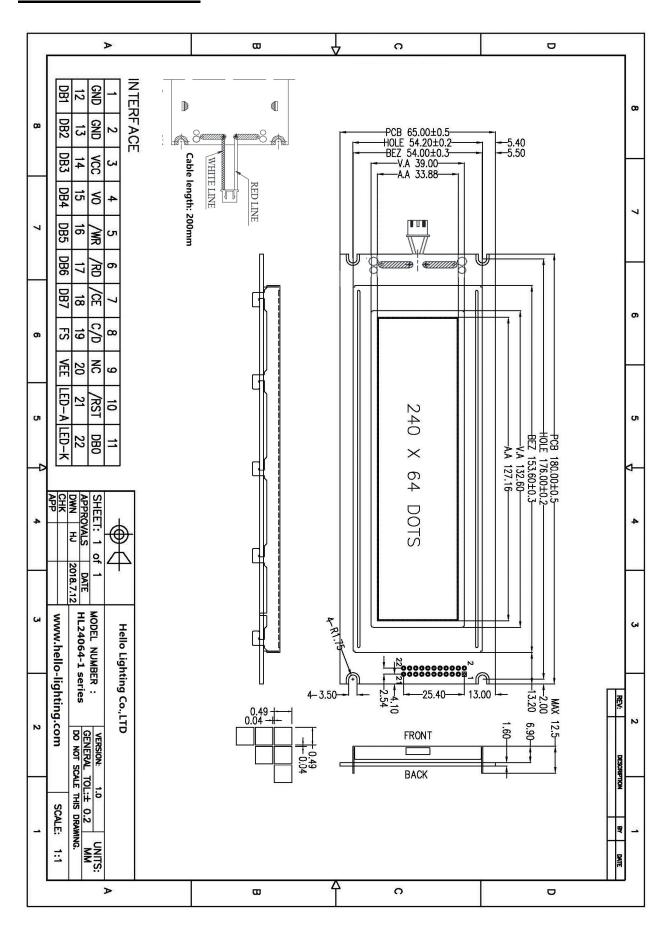
ITEM	SPECIFICATION	UNIT
OUTLINE DIMEMSIONS	180 (W) X65(H) X12.5(D)	mm
VIEWING AREA	132X39	mm
ACTIVE AREA	127.16X33.88	mm
DOT PITCH	0.53X0.53	mm
DISPLAY MODE	FSTN Positive Transflective	mm
NUMBER OF DOTS	240x64	-
DRIVER IC	RA1963C or equ	-
DRIVING METHOD	1/128 Duty, 1/12bias	-
BACKLIGHT TYPE	LED WHITE	-
VIEWING DIRECTION	6 O'clock	-

^{*}See attached drawing for details.

2.BLOCK DIAGRAM:



3.DIMENSIONAL



4. PIN DESCRIPTION:

NO.	PIN NAME	I/0	Description			
1	FG	-	Frame ground			
2	Vss	P	Power ground			
3	Vdd	P	Power supply			
4	V0	I	Negative voltage input for LCD			
5	/WR	I	Write signal			
6	/RD	I	Read signal			
7	/CE		Chip enable signal			
8	C/D		L:data, H: instruction code			
9	NC		No connection			
10	/RESET		Reset signal, active "L"			
11	DB0	IO				
12	DB1	IO				
13	DB2	IO				
14	DB3	IO	Data bus			
15	DB4	IO	Data ous			
16	DB5	IO				
17	DB6	IO				
18	DB7	IO				
19	FS		Font selection:L:8x8 H:6x8			
20	VEE		VLCD OUT			
21	A	P	Power supply BL(+)			
22	K	P	Power supply BL(-)			

5. MAXIMUM ABSOLTE LIMIT:

Item	Symbol	Value	Unit
Power supply voltage for logic	$V_{ m DD}$	-0.3~7	V
LCD supply voltage	Vlcd	0 - 15	V
Operating temperature	Topr	-20 to 70	°C
Storage temperature	Tstg	-30 to 80	°C

Note: Absolute maximum rating is the limit value beyond which the IC maybe broken.

They do not assure operations.

6.ELECTRICAL CHARACTERISTICS

6.1 DC Characteristics (Ta=25°C)

Item		Symbol	Condition	Min	Тур	Max	Unit
Supply Voltage	Logic	V_{DD}	-	4.5/3.0	5.0/3.3	5.5/3.6	V
LCD Supply Volt	age	V_{LCD}	25°C	9	17	25	V
Logic Low Input voltage		$V_{\rm IL}$	-	Vss	-	$0.3 X V_{DD}$	V
Logic High Input voltage		$V_{ m IH}$	-	$0.7~\mathrm{V_{DD}}$	-	V_{DD}	V
Current Consumption All white	Logic	$I_{DD} + I_{IN}$	$V_{DD} = V_{IN} = 3.3V$	-	-	0.5	mA
All white	Analog						
Current Consumption	Logic	Inn +Inv	$V_{DD} = V_{IN} = 3.3V$	-	-	0.5	mΛ
All black	Analog	IDD IIN					mA

Note: Voltage greater than above may damage the module.

All voltages are specified relative to VSS=0V.

6-2 Backlight Electrical-optical Characteristics

1. Stander Lamp Styles(Edge Lighting Type):

The LED chips are distributed over the edge light area of the illumination unit, which gives the less power consumption:

- 2. The Main Advantages of the LED Backlight are as following:
- 2.1 The brightness of the backlight can simply be adjusted by a resistor or a potentiometer.
- 3. Data About LED Backlight:

Item	Symbol	MIN	TYP	MAX	UNIT	Test Condition	Note
Supply Voltage	Vf	3.1	3.5	3.7	V	If=80mA	-
Supply Current	If	ı	80	-	mA	-	-
Reverse Voltage	Vr	ı	-	5	V	10uA	
Power dissipation	Pd	-	336	-	mW	-	
Uniformity for LCM	-	80	-	-	%	If=80mA	3
Life Time	-	ı	50000	-	Hr	If=80 mA	-
Backlight Color	White						

NOTE:

- 1. Average Luminous Intensity of P1-P9
- 2. Uniformity = Min/Max * 100%
- 3.LED life time defined as follows: The final brightness is at 70% of original brightness

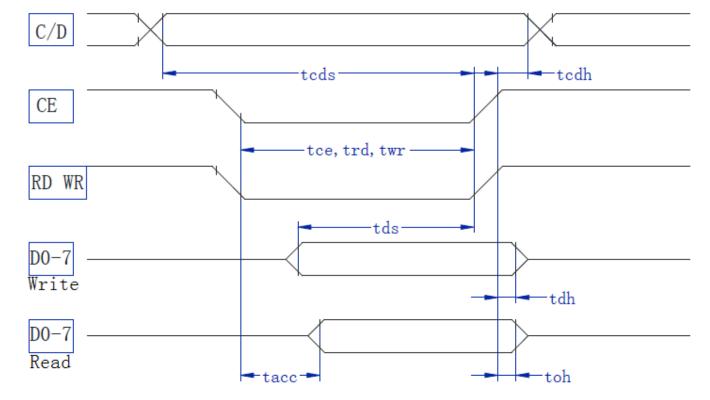
Measured Method: (X*Y: Light Area)(Left Draft as follow)

Internal Circuit Diagram(Right Draft as follow)

(Effective spatial Distribution)

Hole Diameter ø 3mm; 1 to 9 per Position Measured Luminous:

7.AC TIMING7.1 write operation



Item	Symbol	Test conditions	MIN	MAX	UNIT
C/D setup time	tCDS		100	-	ns
C/D hold time	tCDH		10	-	ns
CE,RD,WR pulse	tCE tRD		80	-	ns
width	tWR				
Data set-up time	tDS		80	-	ns
Data hold time	tDH		40	-	ns
Access time	tACC		-	150	ns
Output hold time	tOH		10	10	ns

8. OPTICAL CHARACTERISTICS:

Driving the backlight

No	Jo. ITEM		Symbol Conditions		Specification			Unit	Note
No.	I I EIVI		Symbol	Conditions	Min	Тур	Max	Unit	Note
1 D T		Tr	25℃	-	150	200	Ms	(1)(2)	
1	1 Response Time		Tf	25℃		150	200	IVIS	(1)(2)
2	Contrast F	Rate	Cr	θ=0, Normal viewing angle	-	3	-	-	(1)(3)
3	Viewing Hor. Angle		Θ	CR>10	-50	-	50	Deg	_
Aligie	Ver.	Θ	- CR>10 -	-50	-	50	Deg	-	

Measure Conditions:

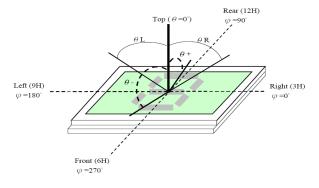
1. Measure surrounding : dark room;

2. Ambient temperature: 25±2°C;

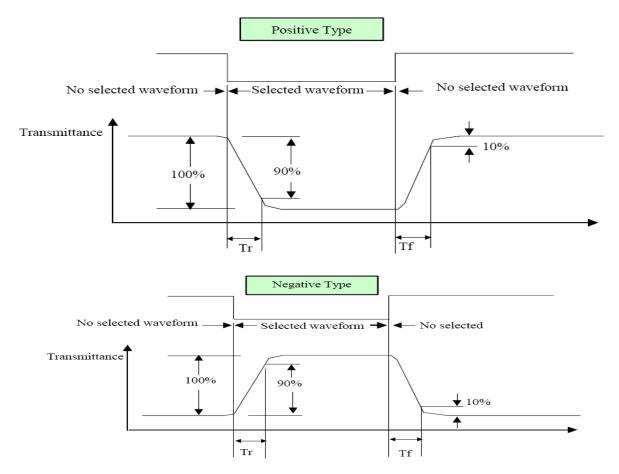
3. 30min.warm-up time.

Note Definition:

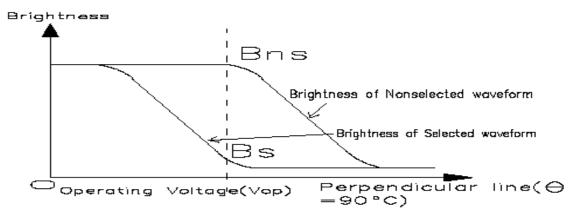
Note(1)Viewing angle range:



Note(2)Response Time:



Note(3)Contrast Ratio Definition:

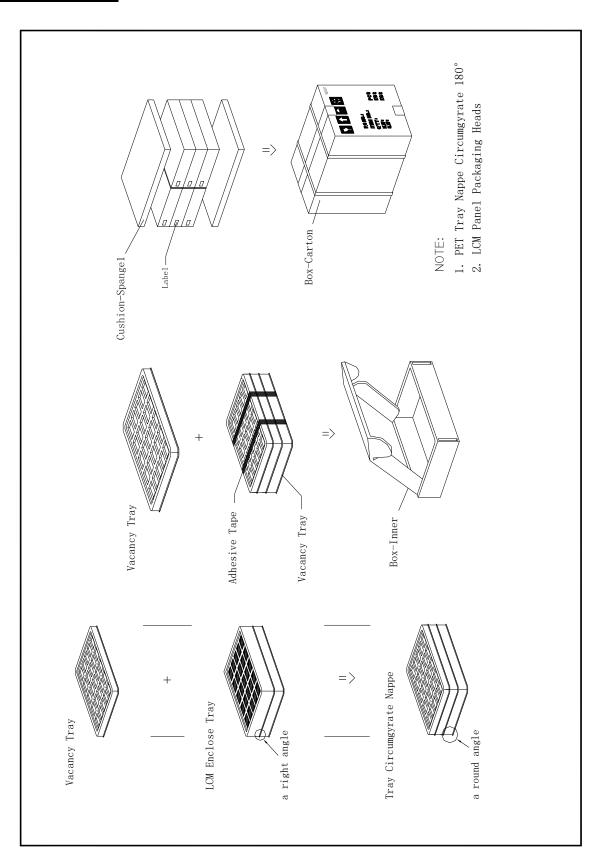


Luminance with all pixel white

Contrast Ratio (Cr)=

Luminance with all pixel black

9.PACKAGE.



10. STANDARD SPECIFICATION FOR RELIABILITY:

Item	Condition	Remark	Regulation	
High temp. Storage	80±5°C 96Hrs	Dry		
High temp. Operating	70±5°C 96Hrs	Dry		
Low temp. Storage	-30±5°C 96Hrs	Dry	Note 2	
Low temp. Operating	-20±5°C 96Hrs	Dry		
Temperature Shock	Cycle: $25\pm5^{\circ}$ C 0.5Hrs \rightarrow -20 ±5 °C 1Hrs \rightarrow 25 $\pm5^{\circ}$ C 0.5Hrs \rightarrow			
(Non-operation state)	$70\pm5^{\circ}$ C 1Hrs	Dry	Note 2	
	Total 32 cycles			
Humidity	40±5℃ & 9095% RH	No	Note 1	
(Non-operation state)	96Hrs	Condensation	Note 2	
Vibration (Non-operation state)	Frequency: 1055 Hz Total Amplitude: 1.5 mm One cycle 60 seconds to 3 directions of X,Y,Z for each 15 minutes.	3 directions	Note 2	
ESD Test	Air: ±6KV, Contact: ±4KV		Note 3	

Note 1: Returned to normal temperature and humidity for 4 hrs.

Note 2: No change on display and in operation under the test condition.

Note 3: Only for display area, if display can resume after program was reset, it is OK.

Note 4: Product cannot sustain at extreme storage conditions for long time.

Test condition:

1) Normal Temperature and Humidity(Ambient Temperature)

Temperature: 25±5°C

Humidity: 65% RH

2) Operation

Unless specified otherwise, test will be conducted under function state.

3) Test Frequency

For destructive tests, such as shock test, will be conducted only once.

11.SPECIFICATION OF QUALITY ASSURANCE:

11.1 Purpose

This standard for Quality Assurance should affirm the quality of LCD Module products to supply.

11.2 Standard for Quality Test

a. Inspection:

Before delivering, the supplier should take the following tests, and affirm the quality of product.

b. Electro-Optical Characteristics:

According to the individual specification to test the product.

c. Test of Appearance Characteristics:

According to the individual specification to test the product.

d. Test of Reliability Characteristics:

According to the definition of reliability on the specification for testing products.

e. Delivery Test:

Before delivering, the supplier should take the delivery test.

- (i) Test method: According to MIL-STD105E.General Inspection Level II take a single time.
- (ii) The defects classify of AQL as following:

Major defect: AQL = 0.65Minor defect: AQL = 2.5Total defects: AQL = 2.5

11.3. Nonconforming Analysis & Deal With Manners

- a. Nonconforming Analysis:
- (i) Purchaser should supply the detail data of non- conforming sample and the non- conforming.
- (ii) After accepting the detail data from purchaser, the analysis of nonconforming should be finished in two weeks.
- (iii) If supplier can not finish analysis on time, must announce purchaser before two weeks.
- b. Disposition of nonconforming:
- (i) If find any product defect of supplier during assembly time, supplier must change the good product for every defect after recognition.
- (ii) Both supplier and customer should analyze the reason and discuss the disposition of nonconforming when the reason of nonconforming is not sure.

11.4. Agreement items

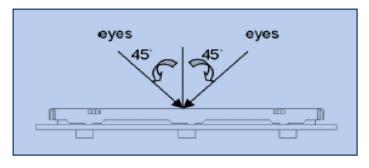
Both sides should discuss together when the following problems happen.

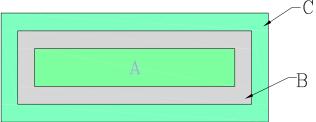
- a. There is any problem of standard of quality assurance, and both sides think that it must be modified.
- b. There is any argument item which does not record in the standard of quality assurance.

c. Any other special problem.

11.5 Standard of The Product Appearance Test

- a. Manner of appearance test: This specification should be applied for both light on and off situation.
- (i) The test must be under 20W × 2 or 40W fluorescent light, and the distance of view must be at 30±5cm.
- (ii) When test the model of transmissive product must add the reflective plate.
- (iii)The test direction is base on about around 10° of vertical line (Left graph)
- (iiii)Temperature: 25±5°C Humidity: 65±10%RH





- (iv) Definition of area (Right graph)
- A. Area: Viewing area. B. Area: Out of viewing area.(Outside viewing area)
- b. Basic principle:
- (i) It will accord to the AQL when the standard can not be described.
- (ii) The sample of the lowest acceptable quality level must be discussed by both supplier and customer when any dispute happened.
- (iii) Must add new item on time when it is necessary.
- c. Standard of inspection: (Unit: mm)

Allowable limits defined in follow Dot defect Table should be met for each white, black, R, G, B raster. The limits apply to the entire area. Missing white in 60% or more of typical (one color, R or G or B) pixel aperture is defined as a bright defect, less than 60% is acceptable. Black spot in 60% or more of typical pixel aperture is defined as a dark defect, less than 60% is acceptable.

Dot defect table:

Item		White dot defect	Black dot defect	Total		
1	Defect	3	3	3		
	counts					
	Combined	No combined dot defect allowed. Two Single dot defect that				
2	defect within 5mm during each dot defect should bed					
	Counts	combined dot defect.				

11.6 Inspection specification AQL inspection standard

Sampling method: MIL-STD-105E, Level II, single sampling

Classify		Item	Note	AQL
		Short or open circuit	1	
		Contrast defect (dim, ghost)		
	5	LC leakage		
	Display state	Flickering		
Major		No display		0.65
		Wrong viewing direction	2	
		Wrong Back-light	7	
	Non-display —	Flat cable or pin reverse	9	
	Wrong or missing component		10	
		Background color deviation	2	
		Black spot and dust	3	
	Display	Line defect	4	
	state	Scratch		
		Rainbow	5	
Minor		Pin hole	6	2.5
MIIIOI	Polarizer	Bubble and foreign material	3	2.3
	Folarizei	Scratch	4	
	PCB,FPC	Scratch	4	
	Soldering	Poor connection	8	
	Wire	Poor connection	9	
	LCD	CHIP OUT	11	

Note on defect classification:

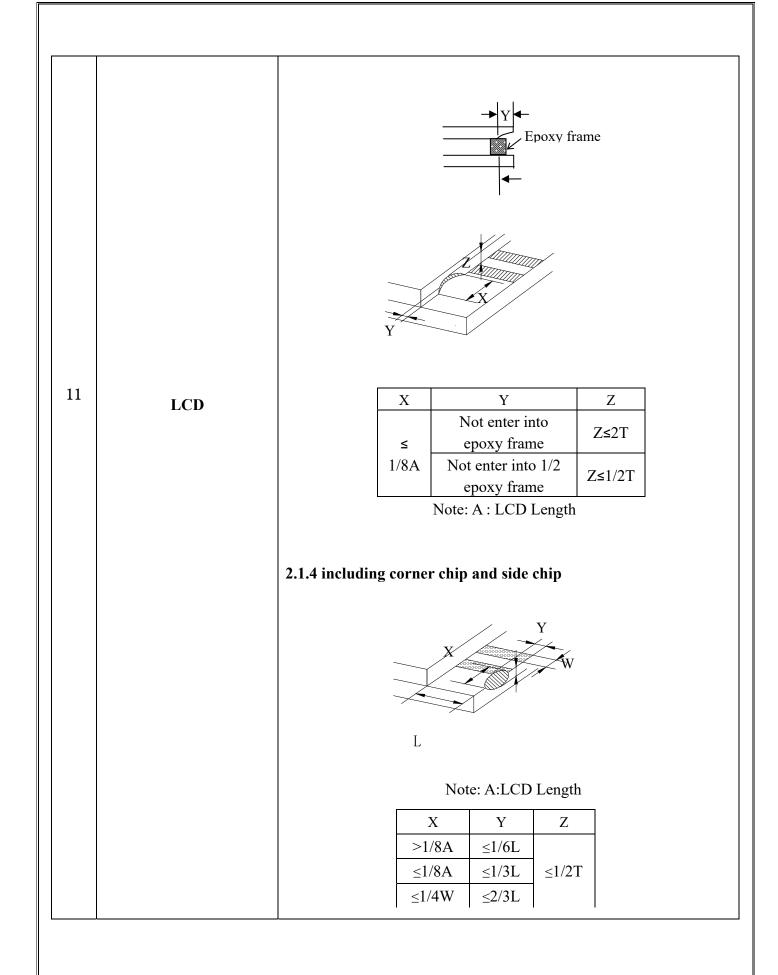
No.	Item		Criterion				
1	Short or open circuit						
	LC leakage						
	Flickering						
	No display	Not allow					
	Wrong viewing direction						
	Wrong Back-light						
	Contrast defect						
2	Background color deviation	Refer to approval sample					
	Point defect, Black spot, dust (incl. Polarizer) ex.: dirt under polarizer, Pinhole of reflector, glass scratch, dirt under glass, scratch on polarizer $\phi = (X+Y)/2$		Point	Acceptable Qty.			
		Y ← Y	Size				
			φ <u><</u> 0.20	Disregard			
3			0.20<♦≤0.25	3 2			
			0.25<¢≤0.30 ¢>0.30	0			
		Unit: mm					
4	Line defect		Line	Acceptable Qty.			
		T	L W	D' 1			
			0.015≥W 3.0≥L 0.03≥W	Disregard 2			
			2.0≥L 0.05≥W				
			1.0≥L 0.1 > W				
			0.05 <w< td=""><td>Applied as point defect</td></w<>	Applied as point defect			
			Unit:	mm			
5	Rainbow	Not more than	two color changes ac	cross the viewing area			

No. Item Criterion

6	Segment pattern W = Segment width $\phi = (X+Y)/2$	(1) Pin hole φ < 0.10mm is acceptable X Y X Y W	Point Size $ \phi \le 1/4W $ $ 1/4W < \phi \le 1/2W $ $ \phi > 1/2W $ Unit:	Acceptable Qty Disregard 1 0 mm
7	Back-light	(1) The color of backlight should correspond its specification.(2) Not allow flickering		
8	Soldering	(1) Not allow heavy dirty and solder ball on PCB or FPC. (The size of dirty refer to point and dust defect) (2) Over 50% of lead should be soldered on Land. Lead Land 50% lead		
9	Wire	 (1) Copper wire should not be rusted (2) Not allow crack on copper wire connection. (3) Not allow reversing the position of the flat cable. (4) Not allow exposed copper wire inside the flat cable. 		
10	РСВ, FPC	(1) Not allow screw rust or damage.(2) Not allow missing or wrong putting of component.		

2.1.1 chip on the surface Epoxy frame LCD 11 Note: A:LCD Length Υ X Z >1/8A ≤0.3mm $\leq 1/2T$ Not enter into epoxy $\leq T$ frame $\leq 1/8A$ Not enter into the $\leq 1/2T$ inner edge of epoxy

2.1.2 Chip on the terminal 11 **LCD** X Y Z >1/8A ≤0.3mm $\leq 1/2T$ ≤1/8A $\leq 1/2L$ ≤T ≤1/8A&≤1mm ≤L ≤T ≤1/8A&≤2mm ≤L $\leq 1/2T$ Note: A:LCD Length. the distance between crack and contact pad must be greater than the width of 1st contact pad. 2.1.3 Chip out on between side



		2.2 Chip out		
11 LCD		1) Chip out is that crackles extend to inner edge. 2) Crackles round epoxy frame will be rejected. 3) Chip out on the terminal will be rejected: Z=T length >1mm or Z <t length="">2mm 4) The chip out at ITO will be rejected. 2.3 Poor cutting</t>		
		X Y Z		
		>1/8 A ≤0.3 ≤1/2T		
		≤1/8 According A to drawing 1/2T≤Z≤T		
		Note: A: LCD Length.		
12	SMT	According to the <acceptable assemblies="" electronic="" of=""> IPC-A-610C class 2 stander. Component missing or function defect are Major defect, the others are Minor defect.</acceptable>		

12. GENERAL PRECAUTIONS

(1) Mounting Method

The panel of the LCD Module consists of two thin glass plates with polarizers which easily get damaged since the Module is fixed by utilizing fitting holes in the printed circuit board. Extreme care should be taken when handling the LCD Modules.

(2) Caution of LCD handling & cleaning

When cleaning the display surface, use soft cloth with solvent (recommended below) and wipe lightly.

- Isopropyl alcohol
- Ethyl alcohol
- Trichlorotrifloroethane

Do not wipe the display surface with dry or hard materials that will damage the polarizer surface. Do not use the following solvent:

- Water
- Ketone
- Aromatics
- (3) Caution against static charge

The LCD Module use C-MOS LSI drivers, so we recommend that you connect any unused input terminal to VDD or VSS, do not input any signals before power is turned on. And ground your body, Work/assembly table. And assembly equipment to protect against static electricity.

(4) Packaging

Modules use LCD elements, and must be treated as such. Avoid intense shock and falls from a height.

- To prevent modules from degradation. Do not operate or store them exposed directly to sunshine or high temperature/humidity.
 - (5) Caution for operation
 - It is indispensable to drive LCD's within the specified voltage limit since the higher voltage than the limit shorten LCD life. An electrochemical reaction due to direct current causes LCD deterioration, Avoid the use of direct current drive.
 - Response time will be extremely delayed at lower temperature than the operating temperature range and on the other hand at higher temperature LCD's show dark color in them.

However those phenomena do not mean malfunction or out of order with LCD's which will come back in the specified operating temperature range.

- If the display area is pushed hard during operation, some font will be abnormally displayed but it resumes normal condition after turning off once.
- As light dew depositing on terminals is a cause for electro-chemical reaction resulting in terminal

open circuit.

Usage under the relative condition of 40°C, 50%RH or less is required.

(6) Storage

In the case of storing for a long period of time (for instance, for years) for the purpose or replacement use, The following ways are recommended.

- Storage in a polyethylene bag with sealed so as not to enter fresh air outside in it, And with no desiccant.
- Placing in a dark place where neither exposure to direct sunlight nor light is. Keeping temperature in the specified storage temperature range.
- Storing with no touch on polarizer surface by the anything else. (It is recommended to store them as they have been contained in the inner container at the time of delivery)

(7) Safety

- It is recommendable to crash damaged or unnecessary LCD into pieces and wash off liquid crystal by using solvents such as acetone and ethanol which should be burned up later.
- When any liquid crystal leaked out of a damaged glass cell comes in contact with your hands, please wash it off well with soap and water.

Hello Lighting co., ltd reserves the right to change this specification. www.hello-lighting.com